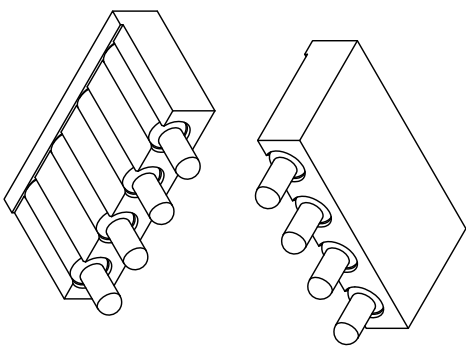
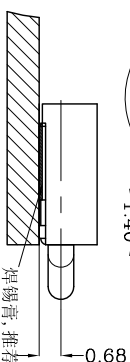
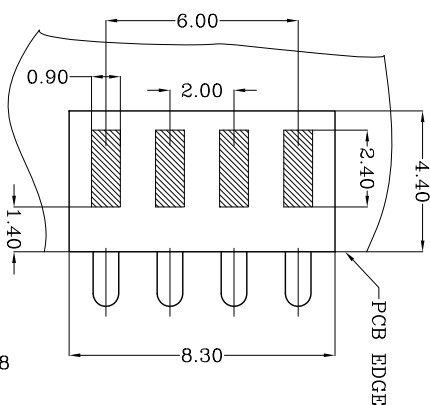


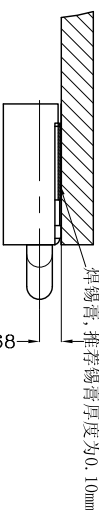
TOP-LINK



 Application status 1

IMPORTANT: The recommended thickness of solder paste is 0.10mm

焊锡膏, 推荐锡膏厚度为 0.10mm



Application status 2
Recommended PCB Layout & Application

1)Body: Min 0.1um Gold plating over min. 1.4um Nickel plating
(Body: 鍍金0.1um Min 鍍底1.4um Min)

2)Plunger: Min 0.4um Gold plating over min. 1.4um Nickel plating
(Plunger: 鍍金0.4um Min 鍍底1.4um Min)

3 Mechanical:

Spring force: Min 0.2N with 0.3mm stroke
1.1 +0.30N/−0.20N with 1.0mm stroke.

Durability(寿命): 10,000 cycle min.

	变更材质		2010/05/12
	改Body结构		2007/12/04
LTR	REVISION RECORD	APVD	DATE

DIMENSIONS IN MM TOLERANCES UNLESS OTHER SPECIFIED		MATL	HT	TR	FIN
$0 = \pm -$ $0.0 = \pm 0.10$ $0.00 = \pm -$ $0.000 = \pm$ ANGLE: $\pm 1^\circ$			—		
DWN	APVD	<i>Top-Link</i> <u>Electronics</u>			
QIN	REL	Top-Link Electronics Ltd.			
CHK					
NAME					
BATTERY POGO CONNECTOR 4 POSITIONS RIGHT ANGLE PGC-1.36-6.1-RA-4P-2.0PH					
SCALE	DWG	SHEET	REV		
1:1	A4	NO. C-1000001	1	OF 1	E
REMOVE BURRS, BREAK SHARP EDGES R0.05 MAX DO NOT SCALE PRINT					

100001-4
PART NUMBER